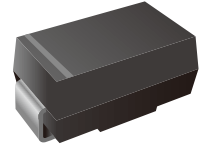


## Surface Mount Schottky Barrier Rectifier

### Features

- The plastic package carries Underwriters Laboratory Flammability Classification 94V-0
- For surface mounted applications
- Metal silicon junction, majority carrier conduction
- Low power loss, high efficiency
- Built-in strain relief, ideal for automated placement
- High forward surge current capability
- Lead free in comply with EU RoHS 2011/65/EU directives



### Mechanical Data

- Case: SMA
- Terminals: leads solderable per MIL-STD-750, Method 2026
- Polarity: Color band denotes cathode end
- Mounting Position: Any

### Ordering Information

Part Number	Shipping	Reel
SS12 THRU SS120-TR5	5000PCS Tape&Reel	13 inches
SS12 THRU SS120-TR7K5	7500PCS Tape&Reel	13 inches

### Maximum Ratings and Electrical Characteristics

Ratings at 25°C ambient temperature unless otherwise specified.

Single phase half-wave 60Hz, resistive or inductive load, for capacitive load current derate by 20%.

Parameters	Symbol	SS12	SS14	SS16	SS18	SS110	SS112	SS115	SS120	Unit	
Maximum repetitive peak reverse voltage	$V_{RRM}$	20	40	60	80	100	120	150	200	V	
Maximum RMS voltage	$V_{RMS}$	14	28	42	56	70	84	105	140	V	
Maximum DC blocking voltage	$V_{DC}$	20	40	60	80	100	120	150	200	V	
Maximum average forward rectified current at $T_L$ (see fig.1)	$I_{(AV)}$	1.0								A	
Peak forward surge current 8.3ms single half sine-wave superimposed on rated load (JEDEC Method)	$I_{FSM}$	30.0								A	
Maximum instantaneous forward voltage at 1.0A	$V_F$	0.55		0.70	0.85			0.90		V	
Maximum DC reverse current at rated DC blocking voltage $T_A=25^\circ\text{C}$ $T_A=100^\circ\text{C}$	$I_R$	0.3			0.2			0.1		mA	
		10			5			2			
Typical junction capacitance (Note1)	$C_J$	110			80					pF	
Typical thermal resistance (Note2)	$R_{\theta JA}$	90									$^\circ\text{C/W}$
Operating junction temperature range	$T_J$	-55 to +125									$^\circ\text{C}$
Storage temperature range	$T_{STG}$	-55 to +150									$^\circ\text{C}$

Note:(1) Measured at 1MHz and applied reverse voltage of 4.0V D.C.

(2) P.C.B. mounted with 2.0" x 2.0"(5.0cm x 5.0cm) copper pad areas.



Characteristics Curves

Fig.1 Forward Current Derating Curve

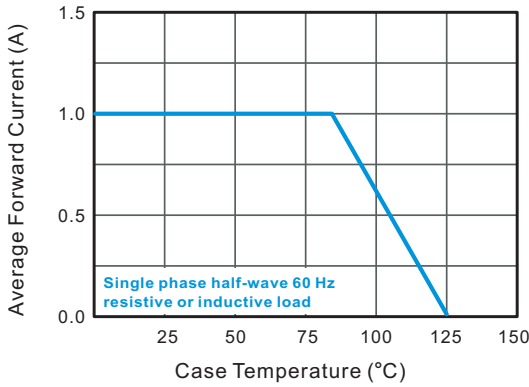


Fig.2 Typical Reverse Characteristics

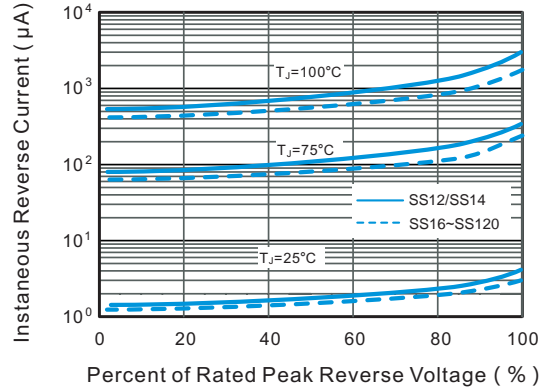


Fig.3 Typical Forward Characteristic

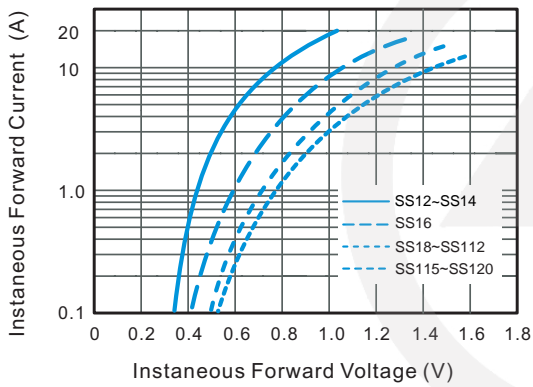


Fig.4 Typical Junction Capacitance

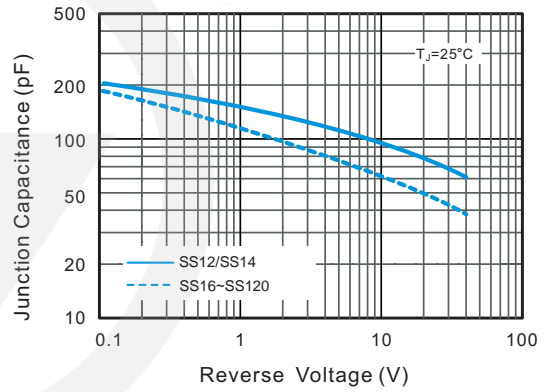


Fig.5 Maximum Non-Repetitive Peak Forward Surge Current

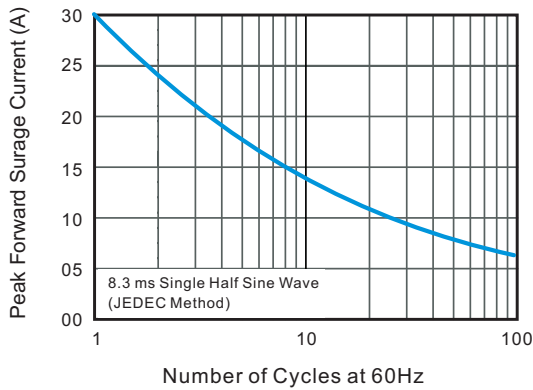
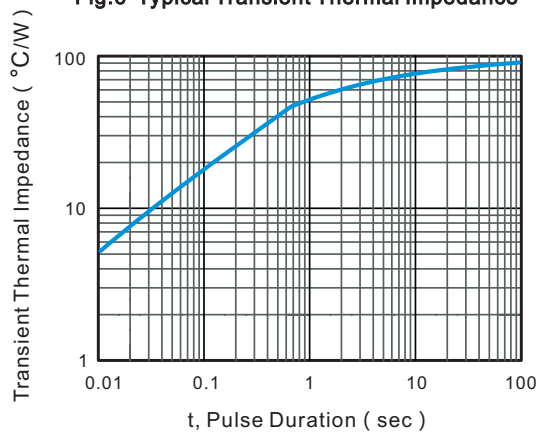
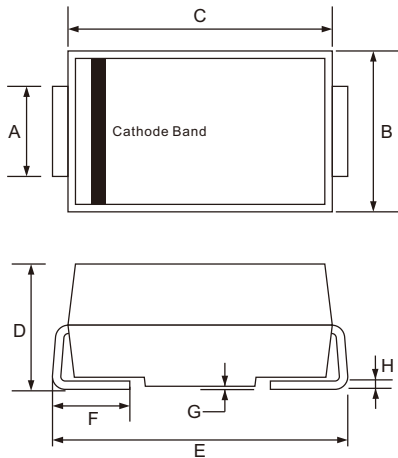


Fig.6 Typical Transient Thermal Impedance



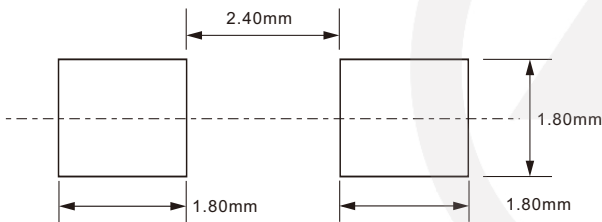
## SMA Package Outline



Unit : mm

SYMBOL	DIMENSIONS	
	MIN.	MAX.
A	1.25	1.65
B	2.30	2.79
C	4.00	4.75
D	1.90	2.50
E	4.70	5.28
F	0.76	1.52
G	0.203 TYP.	
H	0.15	0.31

## SMA Suggested Pad Layout



**Note:**

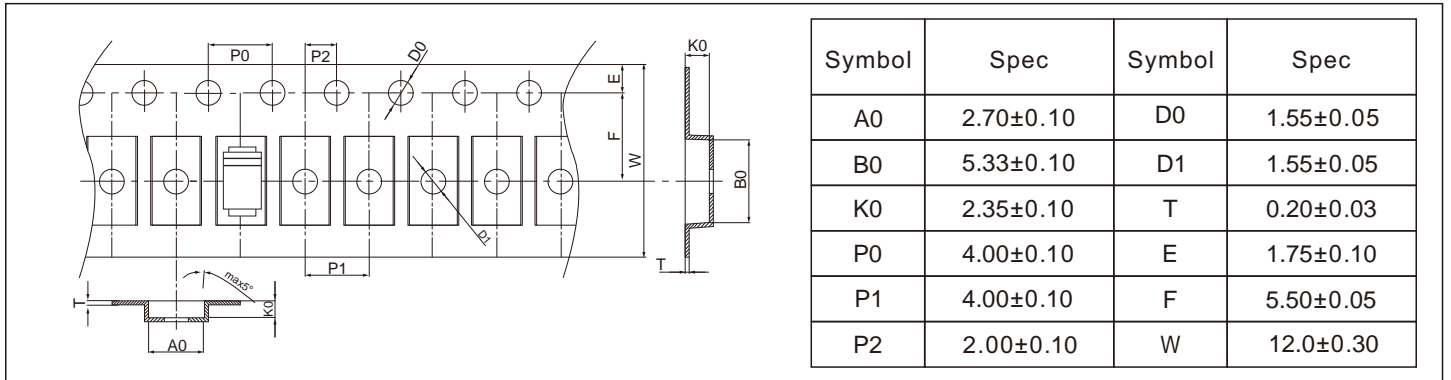
1. Controlling dimension: in millimeters.
2. General tolerance:  $\pm 0.05\text{mm}$
3. The pad layout is for reference purpose only.

## Marking

Type number	Marking code
SS12	SS12
SS14	SS14
SS16	SS16
SS18	SS18
SS110	S110 or SS110
SS112	SS112
SS115	S115 or SS115
SS120	SS120

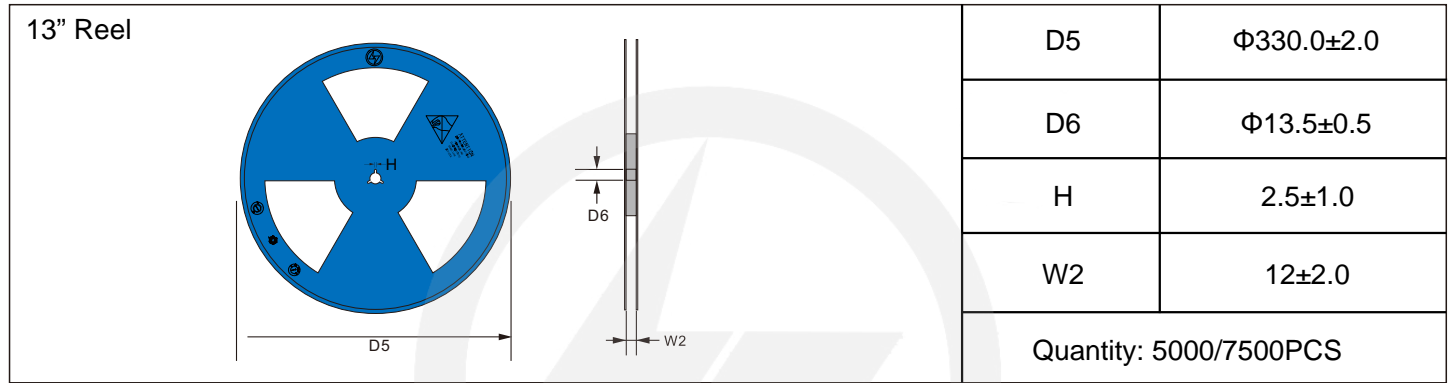
## Carrier Tape Dimensions

Unit : mm

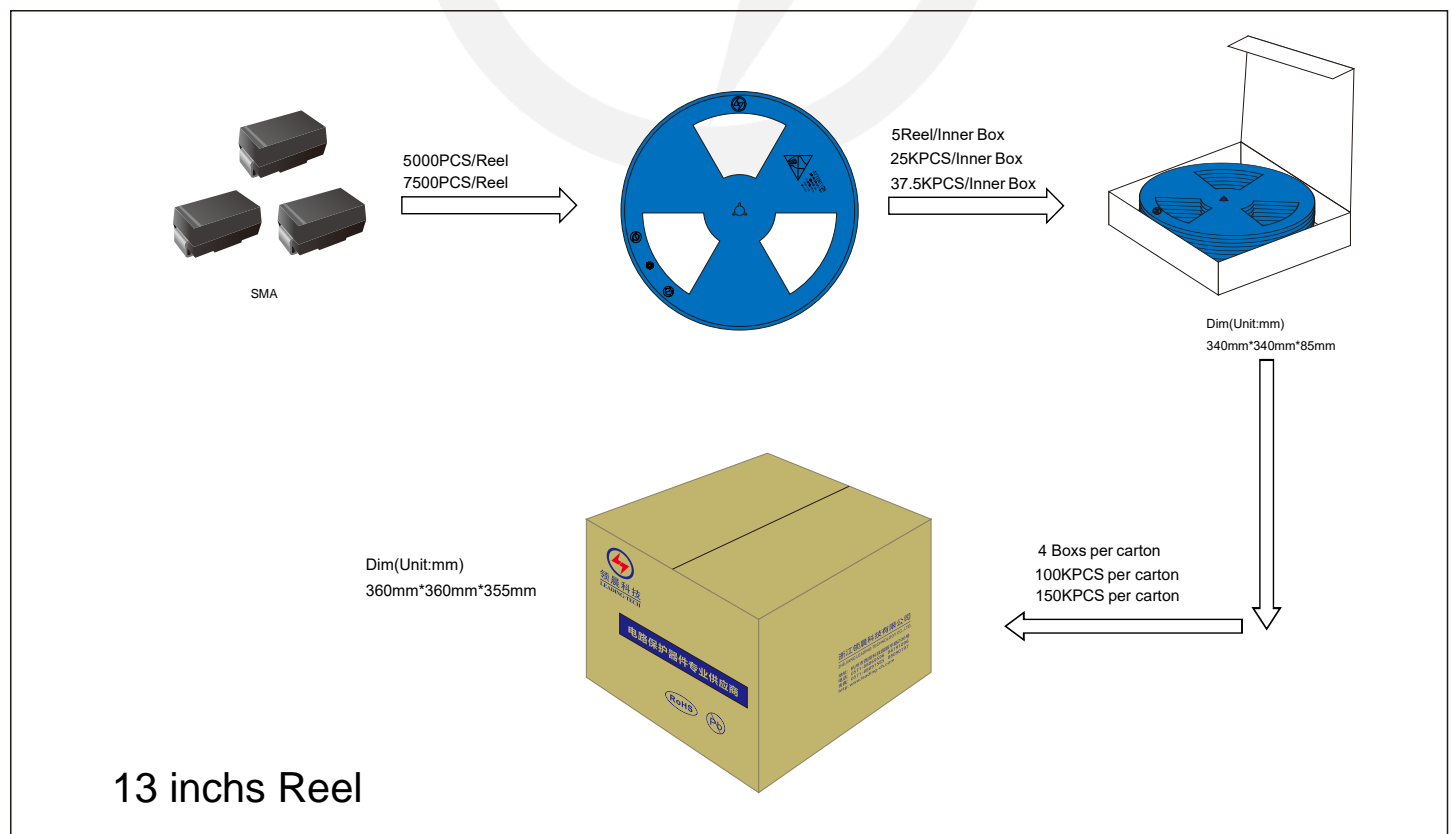


## Reel Dimensions

Unit : mm

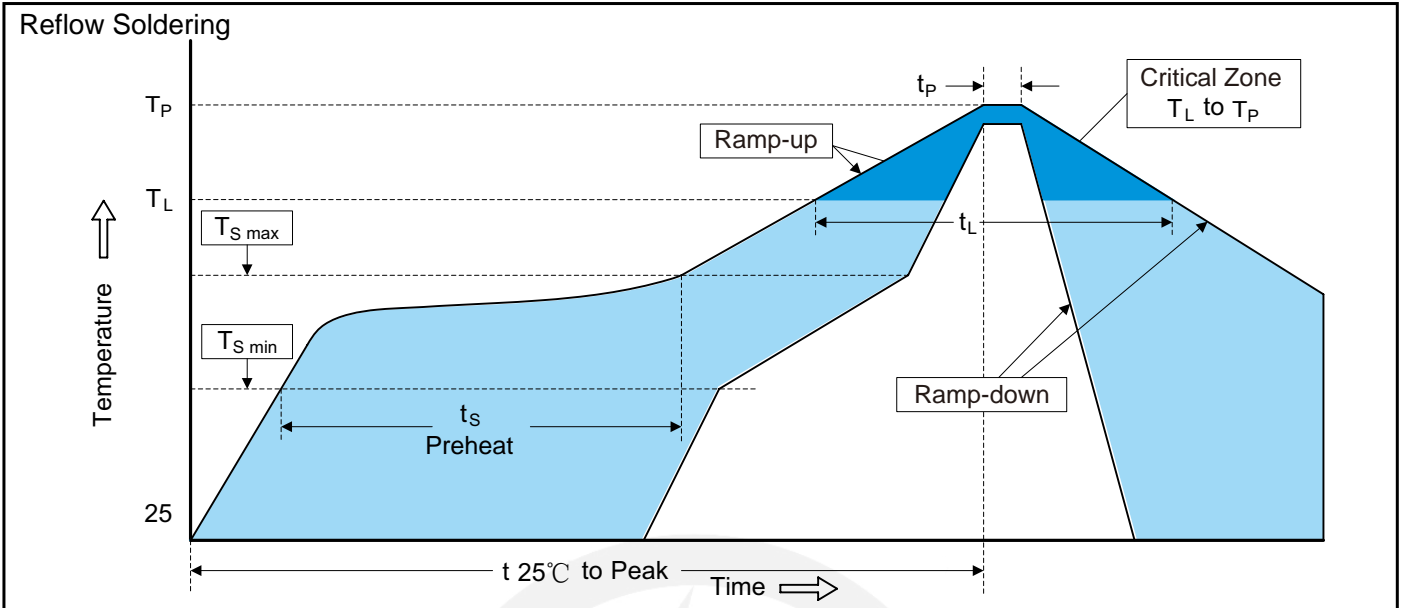


## Packaging





Recommended Soldering Conditions



Recommended Conditions

Profile Feature	Pb-Free Assembly
Average ramp-up rate (T <sub>L</sub> to T <sub>P</sub> )	3°C/second max.
Preheat	
-Temperature Min (T <sub>S min</sub> )	150°C
-Temperature Max (T <sub>S max</sub> )	200°C
-Time (min to max) (t <sub>s</sub> )	60-180 seconds
T <sub>S max</sub> to T <sub>L</sub>	
-Ramp-up Rate	3°C/second max.
Time maintained above:	
-Temperature (T <sub>L</sub> )	217°C
-Time (t <sub>L</sub> )	60-150 seconds
Peak Temperature (T <sub>P</sub> )	260°C
Time within 5°C of actual Peak Temperature (t <sub>p</sub> )	20-40 seconds
Ramp-down Rate	6°C/second max.
Time 25°C to Peak Temperature	8 minutes max.

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## Version Update Information

Series NO.	Enactment/Revision Date	Effective Date	Version	Revision content	Revision Reason	Revision Person	Note
01	2024.9.27	2024.9.27	3.0	New File	/	Ding	
02	2025.06.11	2025.06.11	3.1	Update packaging information	/	Ding	